	CONNECTING NDUSTRIES*	IPC, Bannockt	ourn, Illinois. A	Il rights reserved u ntions.	nder both	This docum level parts,	ent is a declara the declaration	tion of the encompass	substance es all low	s within the manu er level materials	acturer list	ed item. Note: i ne manufacturer	f the item is an as has engineering	ssembly with lower responsibility.	
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					laterials and	als and Mfg Information				
Supplier 1	Information														
Company name* C			Company un	Company unique ID			Unique ID Authority				Resp	Response Date*			
onsemi										2025	2025-05-04				
Contact Na	me	Title - Contact				Phone - Contact*				Ema	Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA				Pro	Product-Env-Stewards@onsemi.com			
Authorized	Representative*	Title - Representative				Phone - Representative*				Ema	Email - Representative*				
Product-En	v-Stewards	Product Enviro Compliance				NA				Pro	Product-Env-Stewards@onsemi.com				
]	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Dat	e Version	Version Manufacturing Site		te	Weight*	UOM	Unit Type	
		LC78615E-01US-H CD-DS		CD-DSP	.D-DSP		2025-05-04					1100.0	mg	Each	
Manufact	turing Proccess Informa	ntion													
Т	Terminal Plating / Grid Array Material		Cerminal Base Alloy J-STD-020 I		J-STD-020 MS	L Rating	Peak Process Body Temperat		ture Max Time at Peak Ter		erature Numb	per of Reflow Cy	cles		
contains Bi CU Alloy			CU Alloy	3			260 C 30		30	se	seconds 3				
Comments															
ATTENTIC	ON: MSL 3 Rated item require	es Bake and D	Dry Pack (after	electrical test)											
for more in	formation regarding material	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.07	mg	Supplier	Silicon (Si)	7440-21-3		4.0558	mg
			Supplier	Polyimide	Proprietary Data		0.0142	mg
Die Attach	0.39	mg	Supplier	Silver (Ag)	7440-22-4		0.2983	mg
			Supplier	Epoxy resins	129915-35-1		0.0916	mg
Lead Frame	250.62	mg	Supplier	Silver (Ag)	7440-22-4		0.6015	mg
			Supplier	Tin (Sn)	7440-31-5		0.6516	mg
			Supplier	Zinc (Zn)	7440-66-6		0.6265	mg
			Supplier	Chromium (Cr)	7440-47-3		0.6767	mg
			Supplier	Copper (Cu)	7440-50-8		248.0637	mg
Mold Compound-Black	836.59	mg		Epoxy Phenol Resin	proprietary data		100.3908	mg
			Supplier	Carbon Black (C)	1333-86-4		3.3464	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		707.7551	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		25.0977	mg
Plating	6.81	mg	В	Bismuth (Bi)	7440-69-9		0.0409	mg
			Supplier	Tin (Sn)	7440-31-5		6.7691	mg
Wire Bond	1.52	mg	Supplier	Palladium (Pd)	7440-05-3		0.0152	mg
			Supplier	Gold (Au)	7440-57-5		1.5048	mg